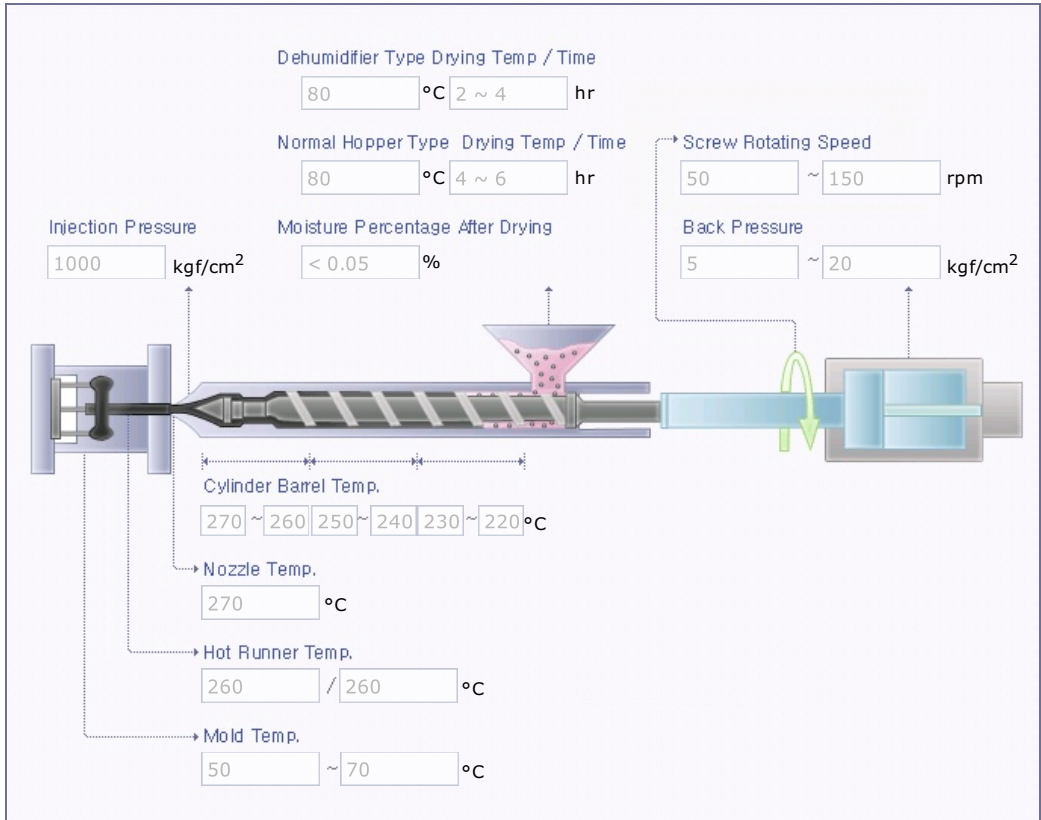


# Processing Guide

**INFINO.**

Grade	NH-1015V
Resin Type	PC/ABS

Processing Guide Diagram



Item		Unit	Representative	
Mold Temp.(Standard Molding)	Stationary Platen	°C	50	
	Moving Platen		70	
Hot Runner Temp.	Manifolder	°C	260	
	Valve Nozzl		260	
Nozzle Temp.		°C	270	
Cylinder Barrel Temp.	NH (Nozzle Heater)	°C	270	
	H1		260	
	H2		250	
	H3		240	
	H4		230	
	H5		220	
Injection Pressure		kgf/cm <sup>2</sup>	1000	
Drying Condition	Dehumidifier Type	Drying Temp	°C	80
		Drying Time	hr	2 ~ 4
	Normal Hopper Type	Drying Temp	°C	80
		Drying Time	hr	4 ~ 6
Moisture Percentage After Drying		%	< 0.05	
Screw Rotating Speed		rpm	50	
		rpm	150	
Back Pressure		kgf/cm <sup>2</sup>	5	
		kgf/cm <sup>2</sup>	20	

1. The value above is the representative value of the NP standard and may have deviation. It can only be used for selecting materials.
2. The value above shall not be regarded as a material specification and cannot be used for molding designs.

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